n re application of:

CHAD A. COBBLEY TONGI JIANG ED A. SCHROCK

Serial No. 08/916,629

Art Unit: 1733

Filing Date: AUGUST 22, 1997

Examiner: GALLAGHER, J.

#14/Vac

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For:

SEMICONDUCTOR DIE ATTACHMENT

METHOD AND APPARATUS

Attorney Docket No. 97-0098

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.56 September 18, 2001

Assistant Commissioner of Patents **BOX RCE** Washington, DC 20231

Dear Sir:

The citations listed on the accompanying form PTO/SB/08, copies attached, may be material to the examination of the subject application and are therefore submitted in compliance with the duty of disclosure defined in 37 CFR §§1.56, 1.97 and 1.98.

This Information Disclosure Statement under 37 CFR §§1.56, 1.97 and 1.98 is not to be construed a representation that a search has been made, that additional material to the examination of this application does not exist, or that any one or more of these citations constitutes prior art under 35 USC §102.

It is requested that the above citations be made of record, if appropriate, in the prosecution of this application.

Respectfully submitted:

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Eratton, Redistration No. 28,418 Stephen

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CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: Assistant Commissioner of Patents, BOX RCE, Washington, DC. 20231 on this 18th day of September, 2001.

Jenl 18,200

Stephen A Gratton, Attorney for Applicants